



2\*0.30Min REF  
以塑胶面为基准  
建议屏蔽罩离塑  
胶面宽度

NOTES:

- MATERIAL:  
HOUSING: LCP MG350, BLACK, UL 94V-0  
CONTACT: C5210-SH, T=0.15MM  
SHELL: SUS304-3/4H T=0.20MM
- FINISH  
CONTACT: 50U'' MIN PLATING OVER ALL  
GOLD FLASH ON THE CONTACT AREA & SOLDER AREA  
SHELL: SELECTIVE GOLD FLASH IN SOLDER TAIL AREA  
50U'' NI MIN. PLATING OVER ALL
- ALL DIMENSIONS MARKED ▼ MUST BE CONTROLLED BY QC
- GP PASSED ACCORD WITH HRD-RoHS-219 STANDARD.
- ALL DIMENSIONS MARKER (XX) MUST BE MEASURED BY FAI.
- RATED PARAMETERS OF CONNECTOR
  - Operating temperature: -40°C to 70°C
  - Rated Current: 0.5A
  - Rated Voltage: 30V AC/DC Per Contact
  - Contact Resistance: 100mΩ MAX
- ELECTRICAL MECHANICAL ENVIRONMENT
  - Dielectric withstanding Voltage: 500V AC 1min.
  - Insulation Resistance: 1000 MΩ Min.
  - Normal Force: 0.03~0.10Kg min
  - Switch PIN positive force: 20gf. Min
  - Insertion Force: 1.0Kg max
  - Push-out Force: 0.2Kg min
  - Durability: SIM CARD 3000 cycles, m-SD 3000 cycles.
- PURE SALT SPRAY TEST REQUIREMENTS FOR CLAMP MOMMNER 24H.

T-CARD PIN NO.	PIN NO.
T1	DAT2
T2	CD/DAT3
T3	CMD
T4	VDD
T5	CLK
T6	VSS
T7	DAT0
T8	DAT1

  

SIM CARD PIN NO.	PIN NO.
P1-A/B	VCC
P2-A/B	RST
P3-A/B	CLK
P5-A/B	GND
P6-A/B	VPP
P7-A/B	I/O

REV.	ECN NO.	DESCRIPTION	DATE	UNITS: mm	GENERAL TOLERANCE	DRAW:	PART NO:
C	E1912702A	锡脚加胶	12/03/2019	DATE: 08/08'2017	X. ±0.25 .X ±0.15 .XX ±0.10 .XXX ±0.05	X.° ±5.00° .X° ±3.00° .XX° ±1.00° .XXX° ±0.50°	S60-2B20F30A
B	E1907372A	变更弹高尺寸管控	07/12/2019	SCALE: 3.5/1		CHECKED:	TITLE: micro sim card & tf card H=3.00mm
A	-----	NEW	08/08/2017	SHEET: 1/1	MATERIAL:	APPROVE:	DRAWING NO:
				REV. A	FINISH: SEE NOTE		

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